

PERFORMANCE BASED ASSESSMENT CONFERENCE SCHOLARSHIP APPLICATION

SUBMISSION OPTIONS:

DEADLINE:

1. E-mail or fax to Melissa Reese March 11, 2011
melissa_reese@valdez.cc
Fax: 907-835-3066
2. Submit on site at conference March 26, 2011 by 1:00 pm

SUBMIT OFFICIAL HIGH SCHOOL TRANSCRIPT WITH SCHOLARSHIP APPLICATION

APPLICATION FOR (circle one):

NOTE: These scholarships are for seniors only with at least 3.0 GPA

Mat Su College PWSCC UAA/CTC UAS

ORGANIZATION YOU ARE INVOLVED WITH (circle):

BPA DECA FCCLA FFA HOSA SkillsUSA

NAME IN FULL: _____

EMAIL ADDRESS: _____

ADDRESS: _____

Street or Box Number

City

State

ZIP

HOME PHONE: () _____ **SCHOOL PHONE:** () _____

NAME OF SCHOOL: _____

SCHOOL ADDRESS: _____

GRADUATION DATE: _____

PLEASE PROVIDE THE FOLLOWING INFORMATION:

1. Number of years you have been a member of your organization:

2. Offices/positions held or contributions to your organization:

3. Honors/awards received while a member of you organization:

4. Service projects in which you were involved while in your organizations?

5. Participation in other high school and community activities:

6. List the CTE high school courses you took or are currently taking related to your CTSO:

7. List any courses you have taken for college credit at the College/University/Technical Center you circled on page one of this application:

8. Cumulative grade point average:

9. Occupational or work experience

	<u>Position</u>	<u>Employer</u>	<u>City</u>	<u>Date</u>
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1)

2)

3)

10. Explain your occupational and education goals:

11. List the names, addresses, and telephone numbers of three references:

12. By signing below you indicate that the College/University/Technical Center may release your name as a scholarship recipient to news agencies.

SIGNATURE OF APPLICANT

DATE

SIGNATURE OF PARENT/GUARDIAN
(IF UNDER 18 YEARS OF AGE)

DATE

Scholarships may require that a minimum GPA be maintained to continue receiving the scholarship.
Additional materials to reinforce student's qualifications may be submitted with this application.